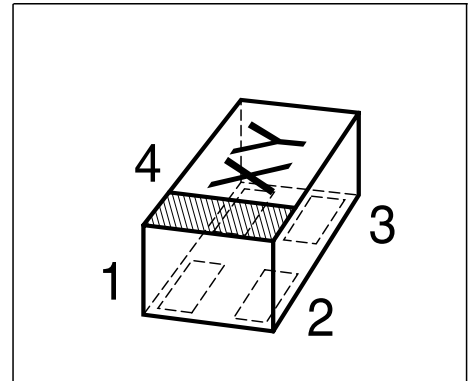


NPN Silicon RF Transistor

Preliminary data

- For low current applications
- For oscillators up to 12 GHz
- Noise figure $F = 1.15$ dB at 1.8 GHz
outstanding $G_{ms} = 22$ dB at 1.8 GHz
- Transition frequency $f_T = 25$ GHz
- Gold metallization for high reliability
- **SIEGET® 25 GHz f_T - Line**
- **Chip Scale Package**
typical dimension: 1.0 x 0.6 x 0.5mm



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration				Package
BFP 405ECSP	ALs	1=B	2=E	3=C	4=E	E-CSP

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	4.5	V
Collector-base voltage	V_{CBO}	15	
Emitter-base voltage	V_{EBO}	1.5	
Collector current	I_C	12	mA
Base current	I_B	1	
Total power dissipation, $T_S = \text{tbd } ^\circ\text{C } ^1)$	P_{tot}	tbd	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Junction - soldering point	R_{thJS}	$\leq \text{tbd}$	K/W
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¹ T_S is measured on the emitter lead at the soldering point to the pcb

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Collector-emitter breakdown voltage $I_C = 1\text{ mA}, I_B = 0$	$V_{(BR)CEO}$	4.5	5	-	V
Collector-base cutoff current $V_{CB} = 5\text{ V}, I_E = 0$	I_{CBO}	-	-	150	nA
Emitter-base cutoff current $V_{EB} = 1.5\text{ V}, I_C = 0$	I_{EBO}	-	-	15	μA
DC current gain $I_C = 5\text{ mA}, V_{CE} = 4\text{ V}$	h_{FE}	50	90	150	-
AC characteristics (verified by random sampling)					
Transition frequency $I_C = 10\text{ mA}, V_{CE} = 3\text{ V}, f = 2\text{ GHz}$	f_T	-	25	-	GHz
Collector-base capacitance $V_{CB} = 2\text{ V}, f = 1\text{ MHz}$	C_{cb}	-	tbd	-	pF
Collector-emitter capacitance $V_{CE} = 2\text{ V}, f = 1\text{ MHz}$	C_{ce}	-	tbd	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}$	C_{eb}	-	tbd	-	
Noise figure $I_C = 2\text{ mA}, V_{CE} = 2\text{ V}, Z_S = Z_{Sopt}, f = 1.8\text{ GHz}$	F	-	1.25	-	dB
Power gain ¹⁾ $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}, Z_S = Z_{Sopt}, Z_L = Z_{Lopt}, f = 1.8\text{ GHz}$	G_{ms}	-	23	-	
Insertion power gain $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}, f = 1.8\text{ MHz}, Z_S = Z_L = 50\Omega$	$ S_{21} ^2$	-	18	-	
Third order intercept point $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}, Z_S=Z_{Sopt}, Z_L=Z_{Lopt}, f = 1.8\text{ GHz}$	IP_3	-	15	-	dBm
1dB Compression point $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}, f = 1.8\text{ GHz}, Z_S=Z_{Sopt}, Z_L=Z_{Lopt}$	P_{-1dB}	-	5	-	

$$^1G_{ms} = |S_{21} / S_{12}|$$